

### Application Data Sheet

#### **Application Information**

Application Type::	Regular
Subject Matter::	Utility
Suggested Group Art Unit::	N/A
CD-ROM or CD-R?::	None
Sequence submission?::	None
Computer Readable Form (CRF)?::	No
Title::	SILICON ELECTRODE PLATE FOR PLASMA ETCHING WITH SUPERIOR DURABILITY (AS AMENDED)
Attorney Docket Number::	09852/0205523-US0
Request for Early Publication?::	No
Request for Non-Publication?::	No
Suggested Drawing Figure::	Fig. 1
Total Drawing Sheets::	1
Small Entity?::	No
Petition included?::	No
Secrecy Order in Parent Appl.?::	No

#### **Applicant Information**

Applicant Authority Type::	Inventor
Primary Citizenship Country::	Japan
Status::	Full Capacity
Given Name::	Hideki
Family Name::	Fujiwara
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Country of Residence::	Japan
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Applicant Authority Type:: Inventor  
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Applicant Authority Type:: Inventor  
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Applicant Authority Type:: Inventor  
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Status:: Full Capacity  
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State or Province of mailing address:: Hyogo-ken  
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Applicant Authority Type:: Inventor  
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Applicant Authority Type:: Inventor  
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Family Name:: Komekyu  
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#### **Correspondence Information**

Correspondence Customer Number:: 07278

#### **Representative Information**

Representative Customer Number:: 07278

#### **Domestic Priority Information**

Application::	Continuity Type::	Parent Application::	Parent Filing Date::
This Application	National Stage of	PCT/JP2005/006134	03/30/05

#### **Foreign Priority Information**

Country::	Application number::	Filing Date::	Priority Claimed::
Japan	2004-108731	04/01/04	Yes
Japan	2004-234961	08/12/04	Yes

#### **Assignee Information**

Assignee name:: SUMCO CORPORATION  
Street of mailing address:: 2-1, Shibaura 1-chome, Minato-ku

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Assignee name:: Mitsubishi Materials Corporation  
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